

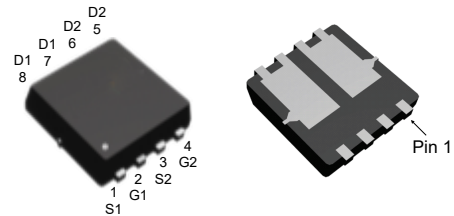
### Features

- N Channel : 30V/40A,  
 $R_{DS(ON)}=7m\Omega(\text{typ.})@V_{GS}=10V$   
 $R_{DS(ON)}=11m\Omega(\text{typ.})@V_{GS}=4.5V$
- P Channel : -30V/-55A,  
 $R_{DS(ON)}=10m\Omega(\text{typ.})@V_{GS}=-10V$   
 $R_{DS(ON)}=14m\Omega(\text{typ.})@V_{GS}=-4.5V$
- 100% UIS +  $R_g$  Tested
- Reliable and Rugged
- Lead Free and Green Devices Available  
 (RoHS Compliant)
- Moisture Sensitivity Level MSL1  
 (per JEDEC J-STD-020D)

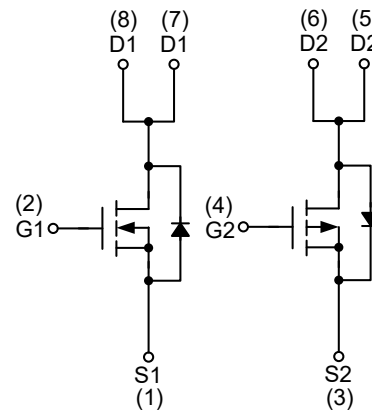
### Applications

- Synchronous Rectification.
- Motor Control.
- High Current, High Speed Switching.
- Portable equipment application.

### Pin Description



PDFN3.3x3.3G-8\_EP2



N-Channel MOSFET

P-Channel MOSFET

**Absolute Maximum Ratings** ( $T_A=25^\circ\text{C}$  Unless Otherwise Noted)

Symbol	Parameter		N Channel	P Channel	Unit
<b>Common Ratings</b>					
$V_{DSS}$	Drain-Source Voltage		30	-30	V
$V_{GSS}$	Gate-Source Voltage		$\pm 20$	$\pm 25$	
$T_J$	Maximum Junction Temperature		150		$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range		-55 to 150		
$I_S$	Diode Continuous Forward Current	$T_C=25^\circ\text{C}$	40	-55	A
$I_D$	Continuous Drain Current	$T_C=25^\circ\text{C}$	40	-55	A
		$T_C=100^\circ\text{C}$	30	-42	A
$I_{DM}^a$	Pulse Drain Current Tested	$T_C=25^\circ\text{C}$	120	-165	A
$P_D$	Maximum Power Dissipation	$T_C=25^\circ\text{C}$	42	54	W
		$T_C=100^\circ\text{C}$	17	21	
$R_{\theta JC}$	Thermal Resistance-Junction to Case		3	2.3	$^\circ\text{C}/\text{W}$
$R_{\theta JA}^c$	Thermal Resistance-Junction to Ambient		80		$^\circ\text{C}/\text{W}$
$I_{AS}^b$	Avalanche Current, Single pulse	$L=0.1\text{mH}$	15	-27	A
$E_{AS}^b$	Avalanche Energy, Single pulse	$L=0.1\text{mH}$	11.25	36	mJ

Note \* : Calculated continuous current based on maximum allowable junction temperature. Bonding wire limitation current is 8A.

Note a : Pulse width limited by maximum junction temperature.

Note b : UIS tested and pulse width limited by maximum junction temperature (initial temperature  $T_J=25^\circ\text{C}$ ).

Note c : Surface Mounted on  $1\text{in}^2$  pad area.

**N Channel Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Test Conditions	N Channel			Unit
			Min.	Typ.	Max.	
<b>Static Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=250\mu A$	30	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=24V, V_{GS}=0V$	-	-	1	$\mu A$
		$T_J=85^\circ\text{C}$	-	-	30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu A$	1.2	1.7	2.2	V
$I_{GSS}$	Gate Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA
$R_{DS(ON)}^d$	Drain-Source On-state Resistance	$V_{GS}=10V, I_{DS}=4A$	-	7	10	m $\Omega$
		$V_{GS}=4.5V, I_{DS}=2.4A$	-	11	15	
<b>Diode Characteristics</b>						
$V_{SD}^d$	Diode Forward Voltage	$I_{SD}=4A, V_{GS}=0V$	-	0.8	1.1	V
$t_{rr}$	Reverse Recovery Time	$I_{SD}=4A, di_{SD}/dt=100A/\mu s$	-	11	-	ns
$Q_{rr}$	Reverse Recovery Charge		-	2	-	nC
<b>Dynamic Characteristics<sup>e</sup></b>						
$R_G$	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$	-	2.8	-	$\Omega$
$C_{iss}$	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=15V,$ Frequency=1.0MHz	-	823	1070	pF
$C_{oss}$	Output Capacitance		-	106	-	
$C_{rss}$	Reverse Transfer Capacitance		-	74	-	
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=15V, R_L=15\Omega,$ $I_{DS}=1A, V_{GEN}=10V,$ $R_G=6\Omega$	-	11	20	ns
$t_r$	Turn-on Rise Time		-	7	13	
$t_{d(OFF)}$	Turn-off Delay Time		-	29	53	
$t_f$	Turn-off Fall Time		-	6	11	
<b>Gate Charge Characteristics<sup>e</sup></b>						
$Q_g$	Total Gate Charge	$V_{DS}=15V, V_{GS}=4.5V,$ $I_{DS}=4A$	-	7	11	nC
$Q_g$	Total Gate Charge	$V_{DS}=15V, V_{GS}=10V,$ $I_{DS}=4A$	-	14.3	21	
$Q_{gs}$	Gate-Source Charge		-	2	-	
$Q_{gd}$	Gate-Drain Charge		-	2.5	-	

 Note d : Pulse test ; pulse width $\leq 300\mu s$ , duty cycle $\leq 2\%$ .

Note e : Guaranteed by design, not subject to production testing.

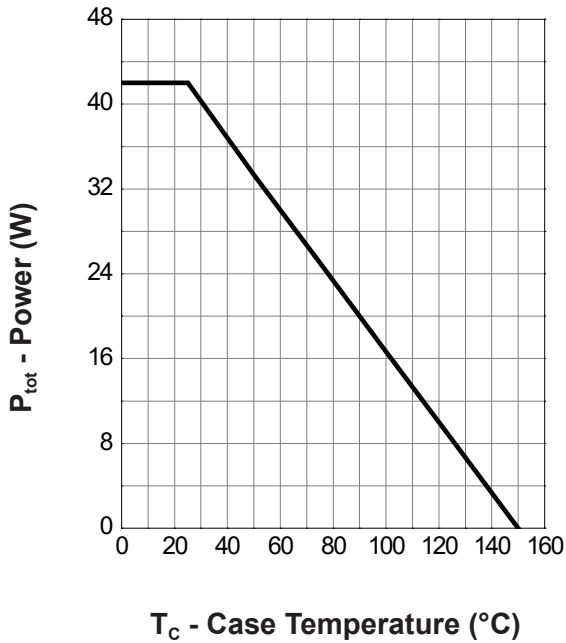
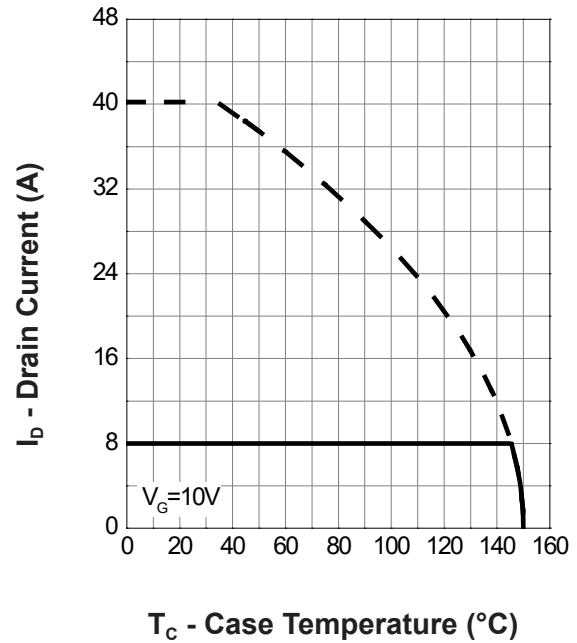
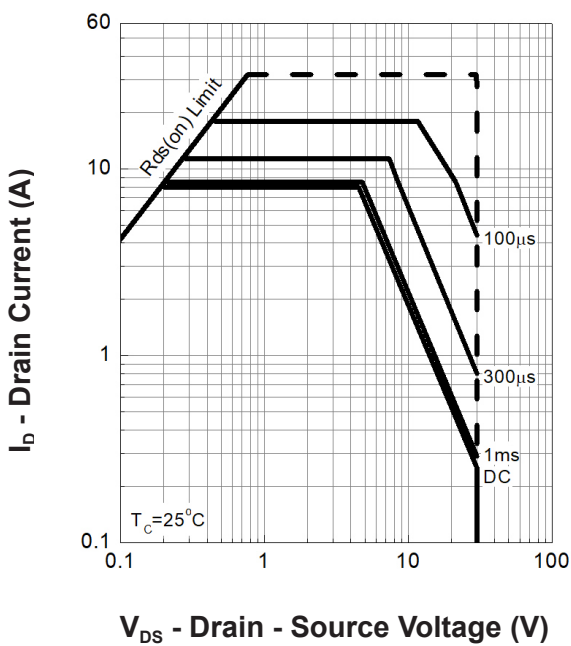
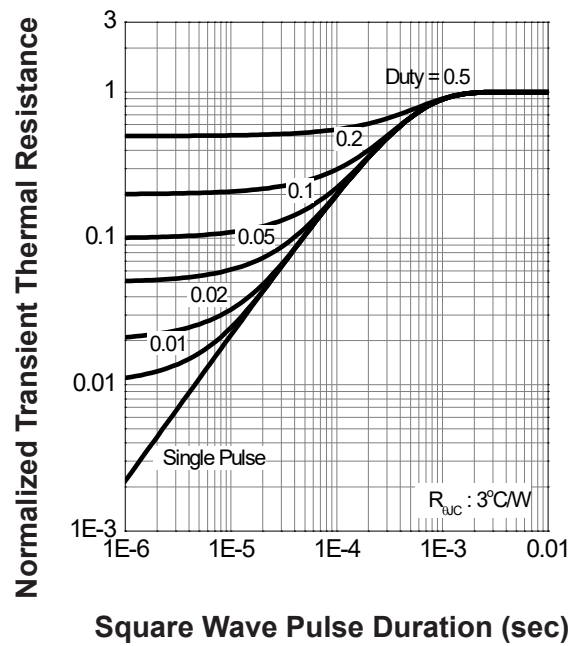
**P Channel Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Test Conditions	P Channel			Unit
			Min.	Typ.	Max.	
<b>Static Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=-250\mu A$	-30	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=-24V, V_{GS}=0V$	-	-	-1	$\mu A$
		$T_J=85^\circ C$	-	-	-30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu A$	-1.0	-1.8	-2.5	V
$I_{GSS}$	Gate Leakage Current	$V_{GS}=\pm 25V, V_{DS}=0V$	-	-	$\pm 100$	nA
$R_{DS(ON)}^d$	Drain-Source On-state Resistance	$V_{GS}=-10V, I_{DS}=-4A$	-	10	14	m $\Omega$
		$V_{GS}=-4.5V, I_{DS}=-2.4A$	-	14	18	
<b>Diode Characteristics</b>						
$V_{SD}^d$	Diode Forward Voltage	$I_{SD}=-4A, V_{GS}=0V$	-	-0.8	-1.1	V
$t_{rr}$	Reverse Recovery Time	$I_{SD}=-4A, dI_{SD}/dt=100A/\mu s$	-	18	-	ns
$Q_{rr}$	Reverse Recovery Charge		-	7	-	nC
<b>Dynamic Characteristics<sup>e</sup></b>						
$R_G$	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1MHz$	-	10	-	$\Omega$
$C_{iss}$	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=-15V,$ Frequency=1.0MHz	-	1754	2250	pF
$C_{oss}$	Output Capacitance		-	238	-	
$C_{rss}$	Reverse Transfer Capacitance		-	165	-	
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=-15V, R_L=-15\Omega,$ $I_{DS}=-1A, V_{GEN}=-10V,$ $R_G=6\Omega$	-	10	18	ns
$t_r$	Turn-on Rise Time		-	10	18	
$t_{d(OFF)}$	Turn-off Delay Time		-	98	176	
$t_f$	Turn-off Fall Time		-	85	153	
<b>Gate Charge Characteristics<sup>e</sup></b>						
$Q_g$	Total Gate Charge	$V_{DS}=-15V, V_{GS}=-4.5V,$ $I_{DS}=-4A$	-	13.7	-	nC
$Q_g$	Total Gate Charge	$V_{DS}=-15V, V_{GS}=-10V,$ $I_{DS}=-4A$	-	26.8	40	
$Q_{gs}$	Gate-Source Charge		-	4.3	-	
$Q_{gd}$	Gate-Drain Charge		-	5.4	-	

 Note d : Pulse test ; pulse width $\leq 300\mu s$ , duty cycle $\leq 2\%$ .

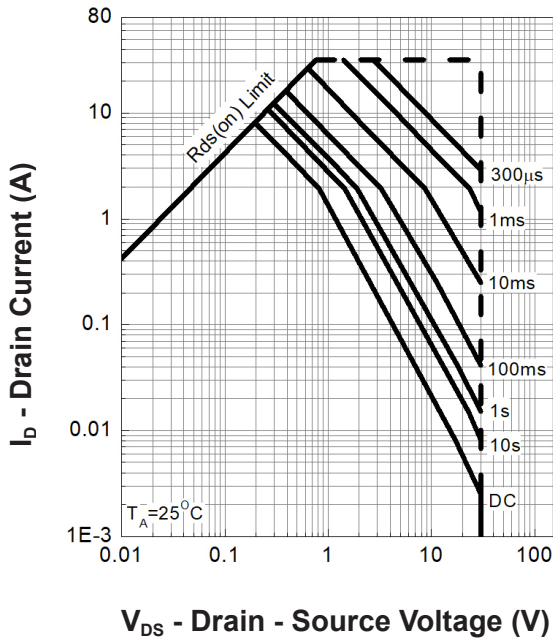
Note e : Guaranteed by design, not subject to production testing.

## N Channel Typical Operating Characteristics

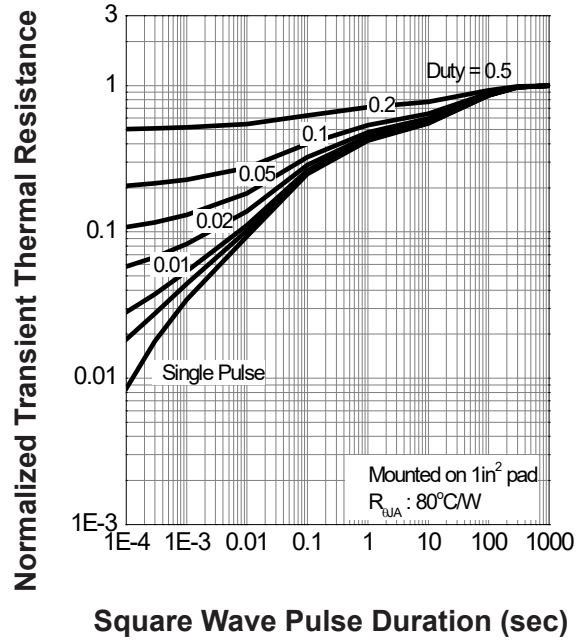
**Power Dissipation**

**Drain Current**

**Safe Operation Area**

**Thermal Transient Impedance**


### N Channel Typical Operating Characteristics(Cont.)

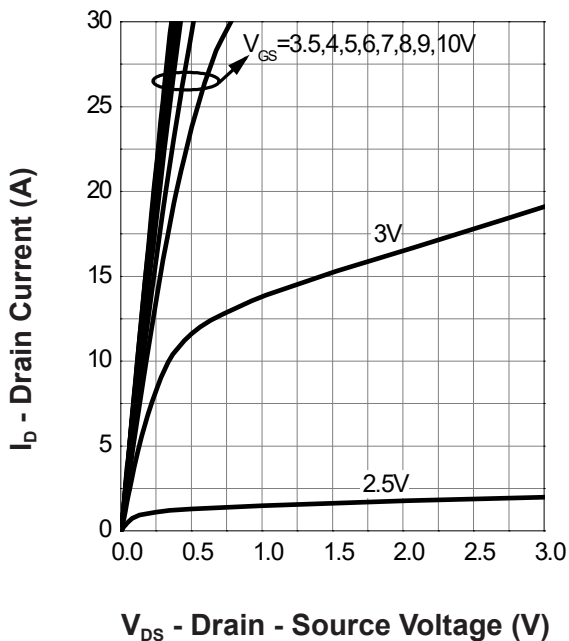
**Safe Operation Area**



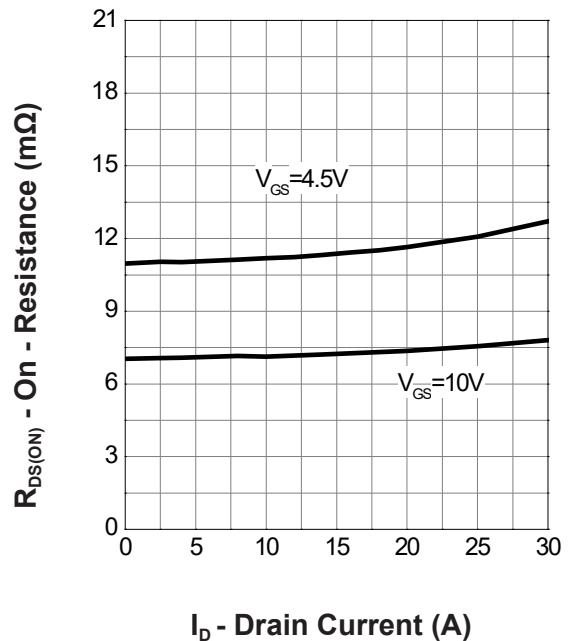
**Thermal Transient Impedance**

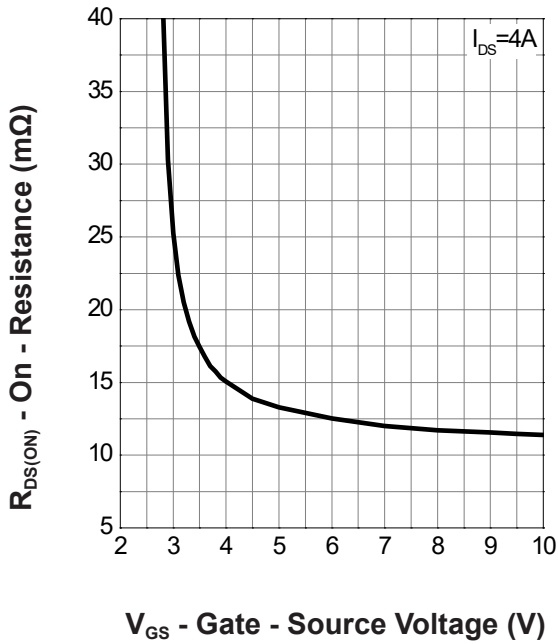
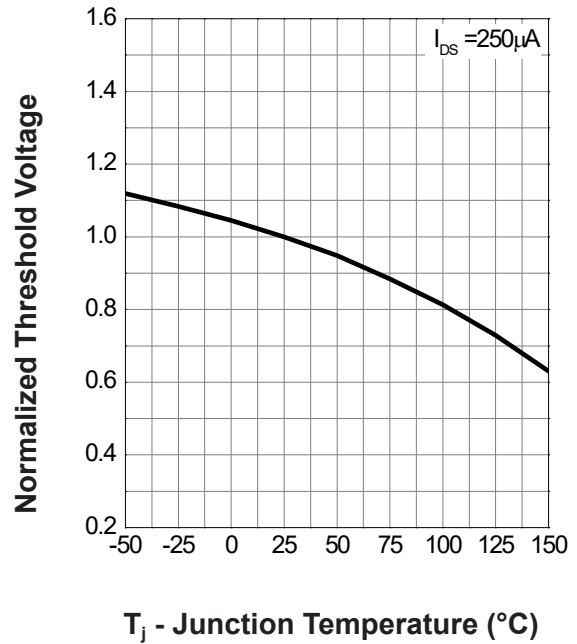
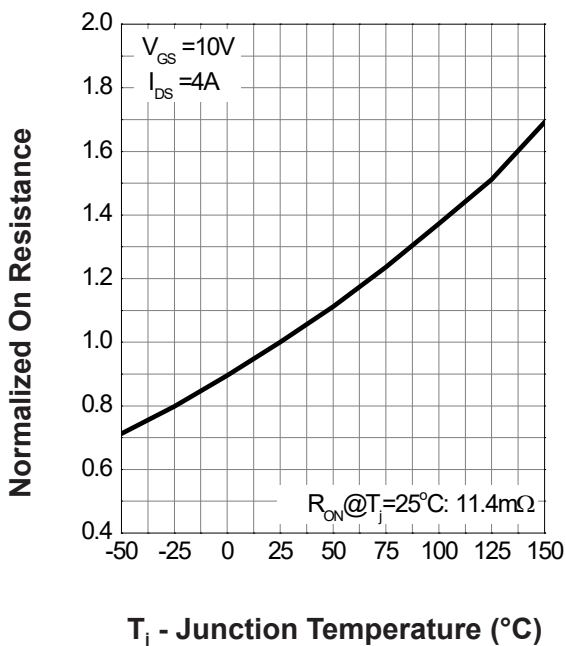
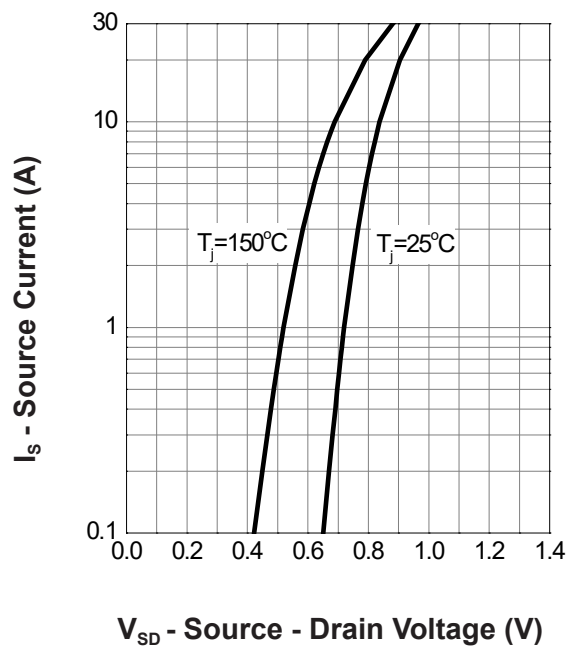


**Output Characteristics**



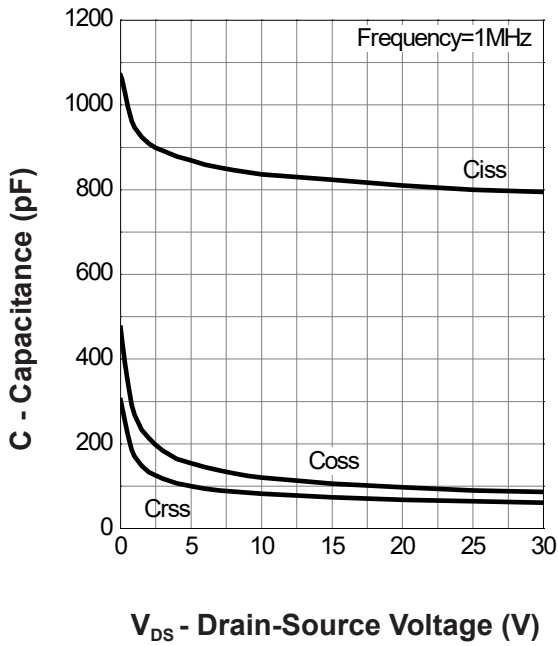
**Drain-Source On Resistance**



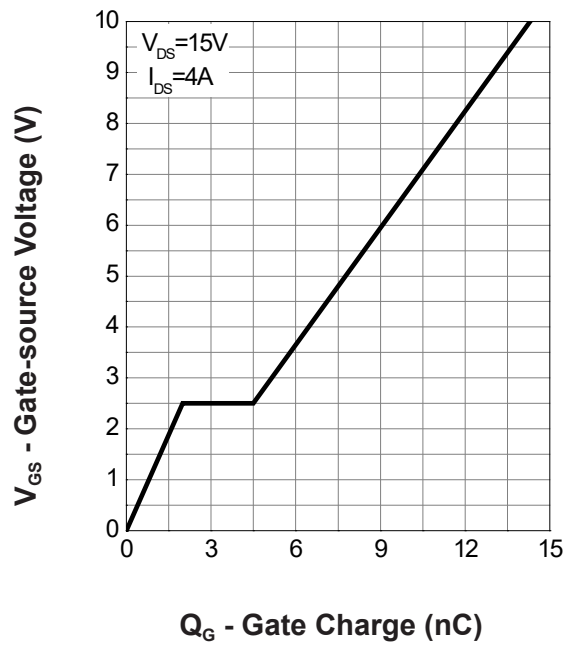
**N Channel Typical Operating Characteristics(Cont.)**
**Gate-Source On Resistance**

**Gate Threshold Voltage**

**Drain-Source On Resistance**

**Source-Drain Diode Forward**


### N Channel Typical Operating Characteristics(Cont.)

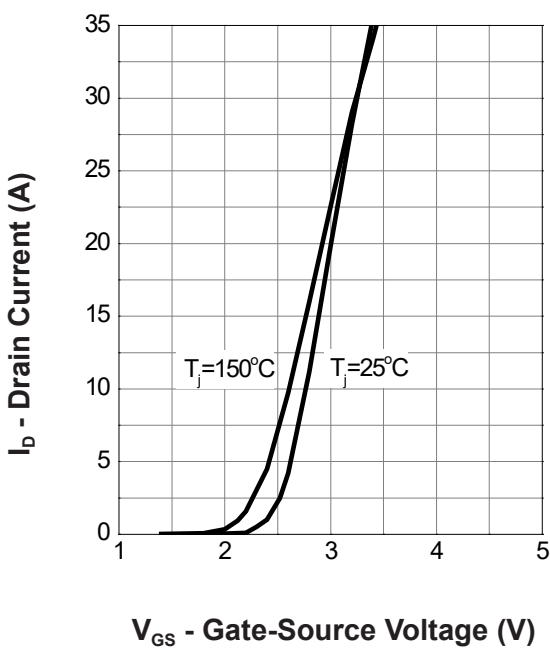
Capacitance



Gate Charge

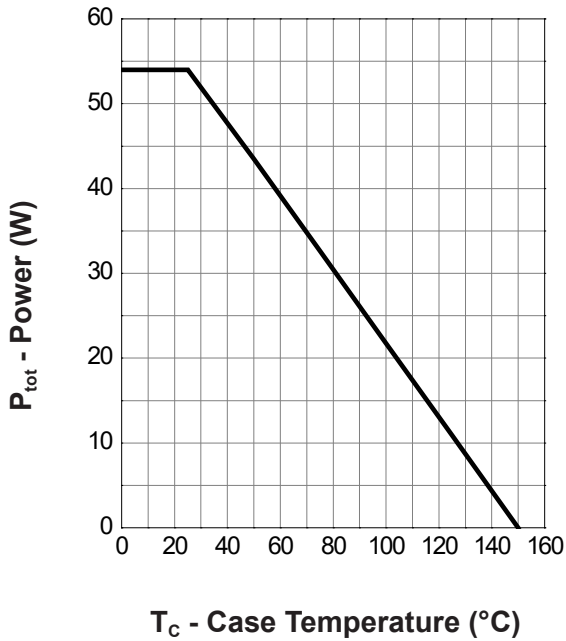


Transfer Characteristics

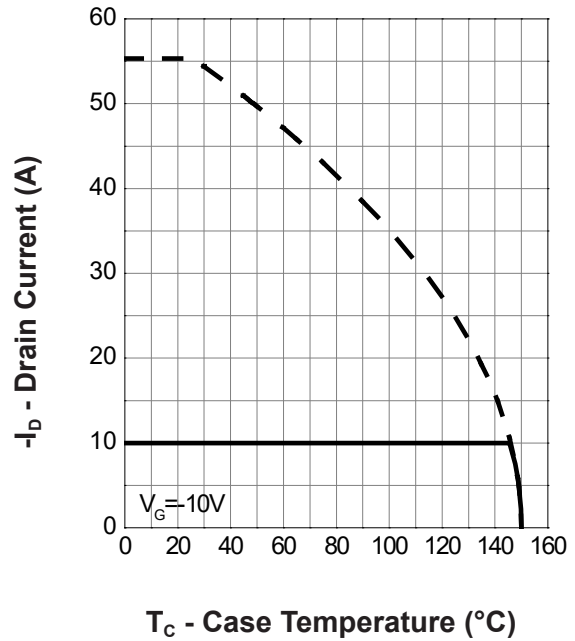


### P Channel Typical Operating Characteristics

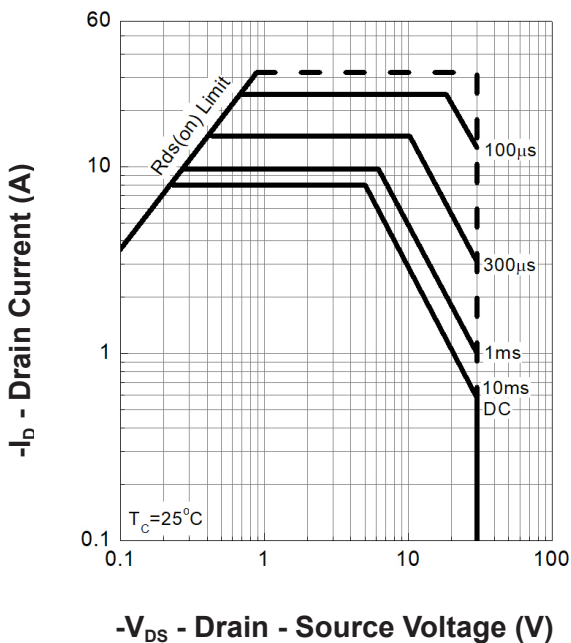
**Power Dissipation**



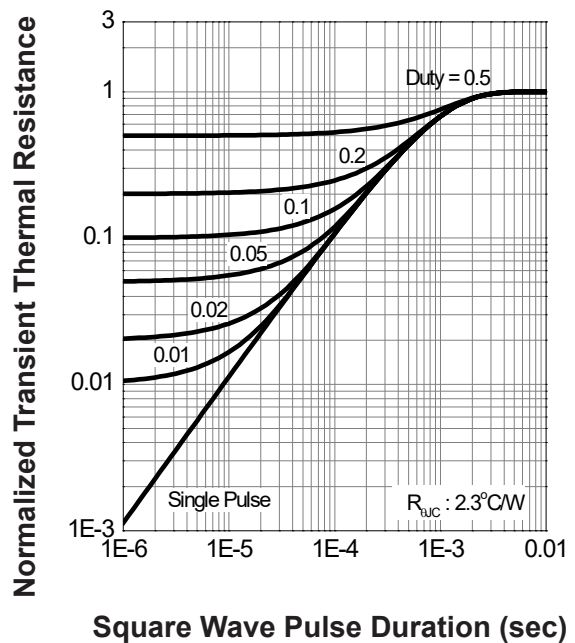
**Drain Current**



**Safe Operation Area**

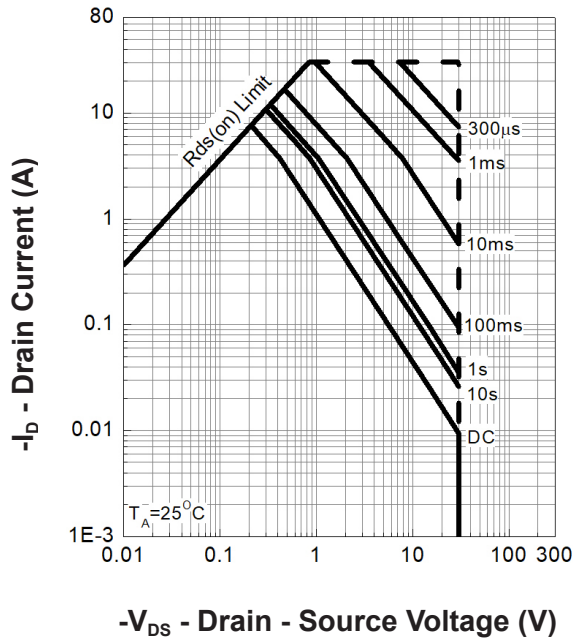


**Thermal Transient Impedance**

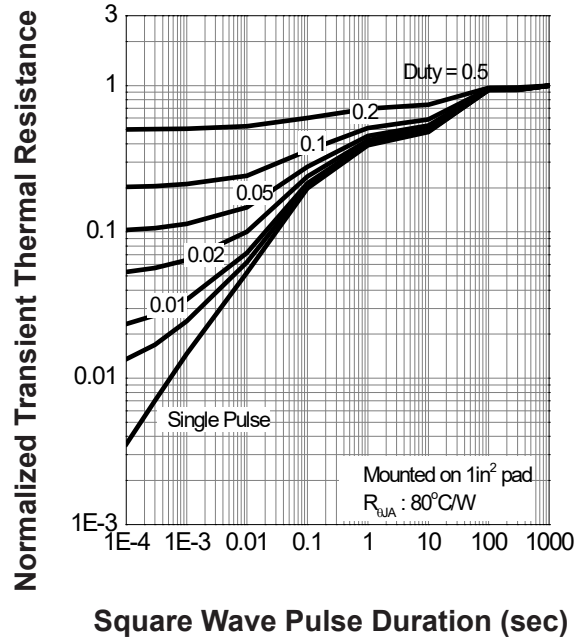


### P Channel Typical Operating Characteristics(Cont.)

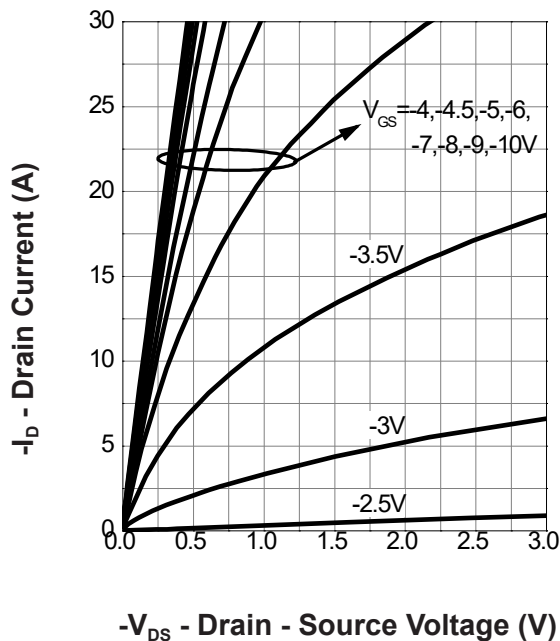
Safe Operation Area



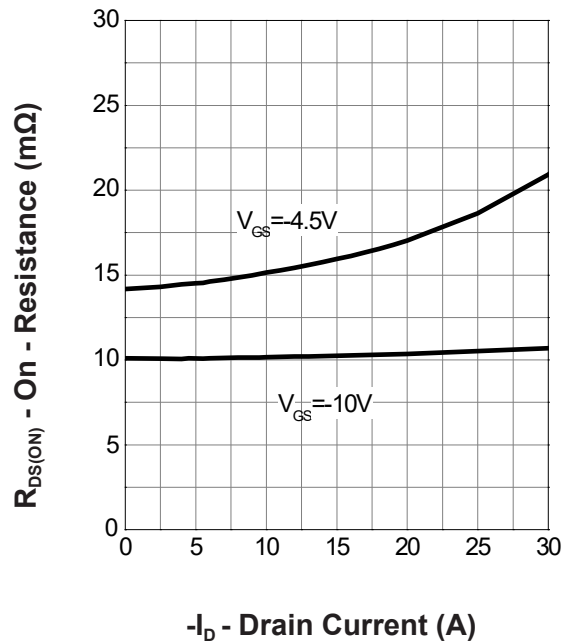
Thermal Transient Impedance

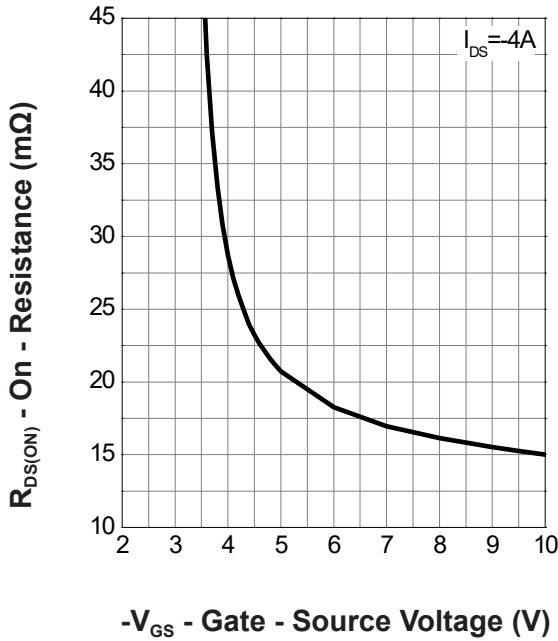
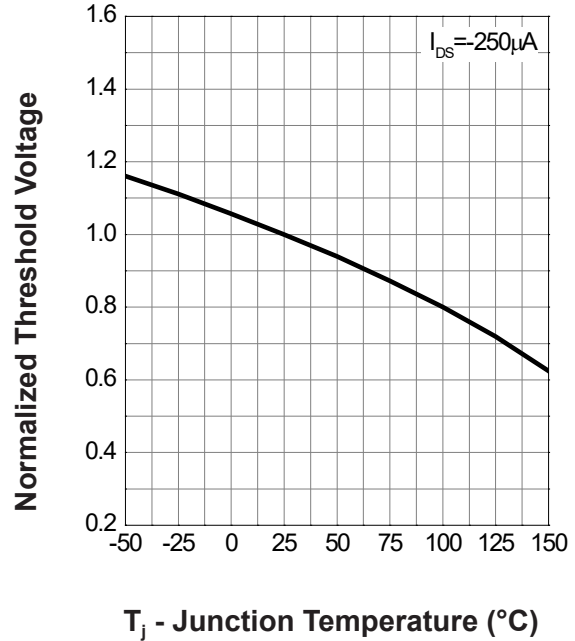
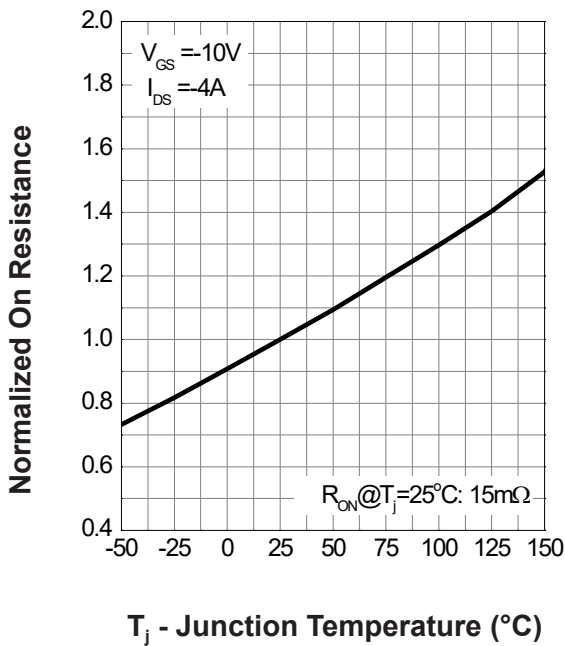
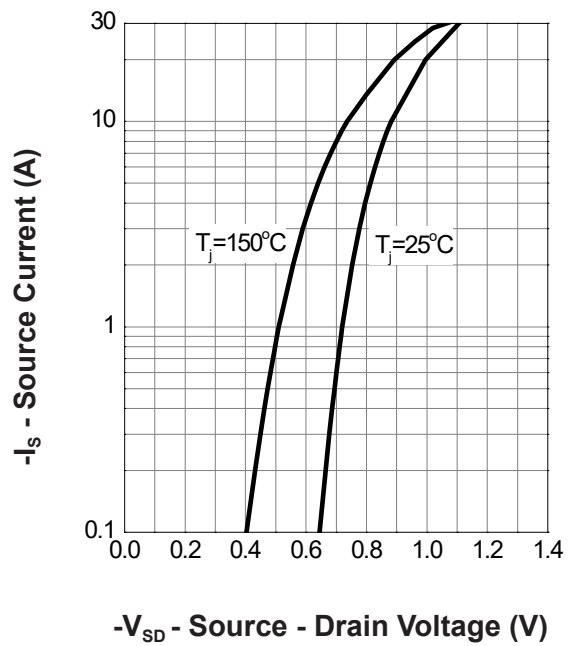


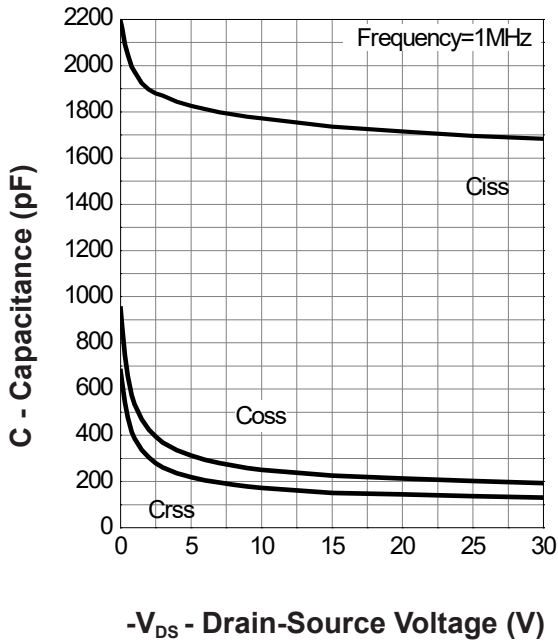
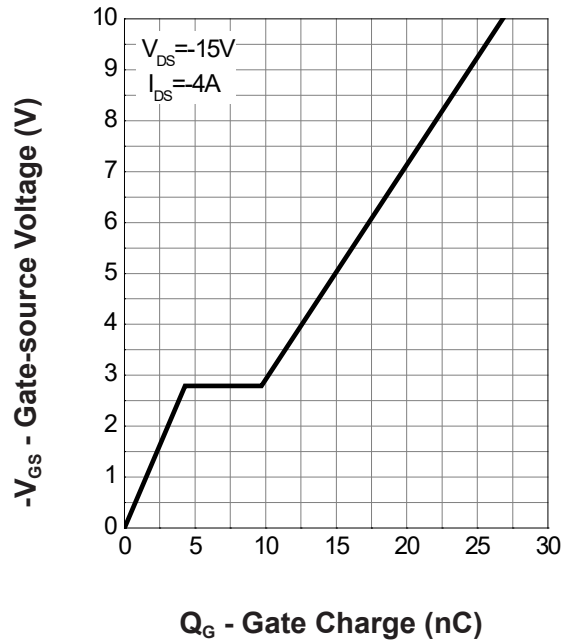
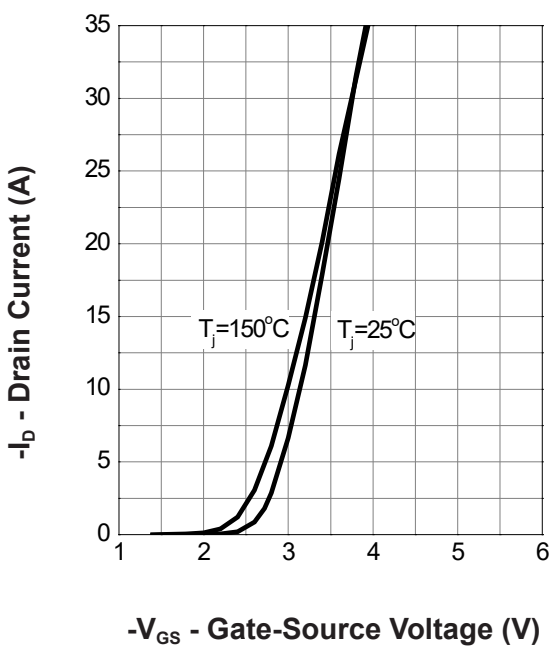
Output Characteristics

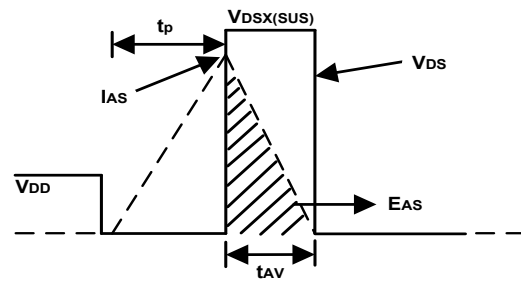
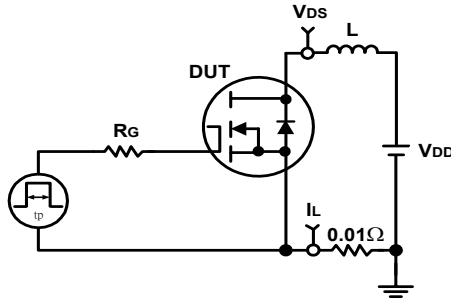
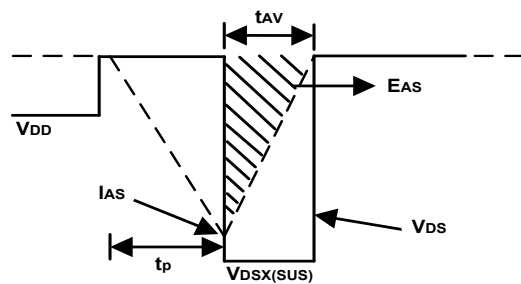
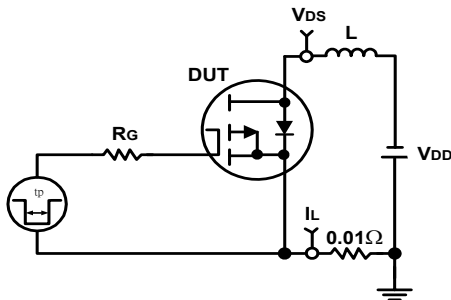
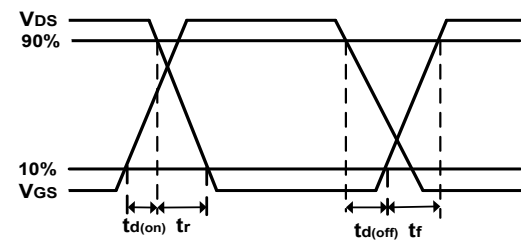
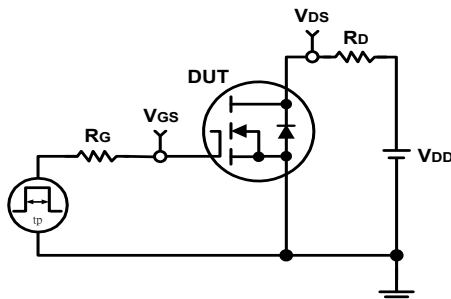
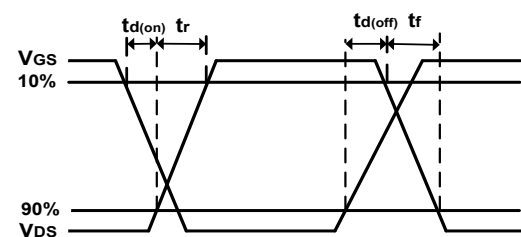
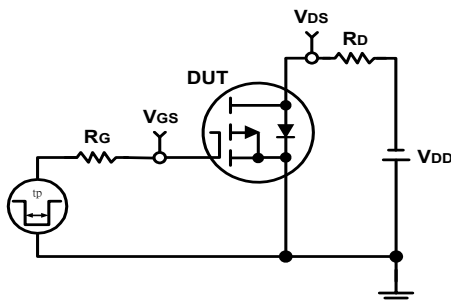


Drain-Source On Resistance



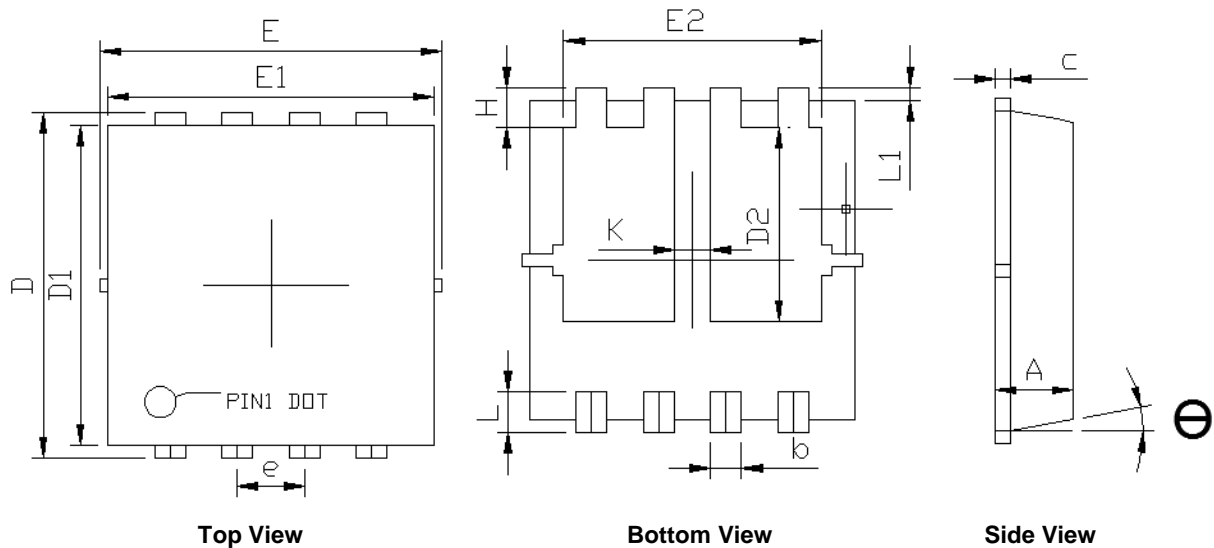
**P Channel Typical Operating Characteristics(Cont.)**
**Gate-Source On Resistance**

**Gate Threshold Voltage**

**Drain-Source On Resistance**

**Source-Drain Diode Forward**


**P Channel Typical Operating Characteristics(Cont.)**
**Capacitance**

**Gate Charge**

**Transfer Characteristics**


**Avalanche Test Circuit and Waveforms**
**N Channel**

**P Channel**

**Switching Time Test Circuit and Waveforms**
**N Channel**

**P Channel**


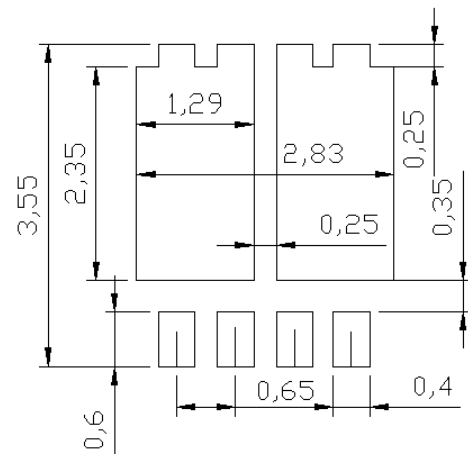
## Package Information

PDFN3.3x3.3G-8\_EP2



SYMBOLS	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
	A	0.70	0.80	0.028
b	0.25	0.35	0.010	0.014
c	0.10	0.25	0.004	0.010
D	3.25	3.45	0.128	0.136
D1	3.00	3.20	0.118	0.126
D2	1.78	1.98	0.070	0.078
E	3.00	3.40	0.118	0.134
E1	3.00	3.20	0.118	0.126
E2	2.39	2.59	0.094	0.102
e	0.65BSC		0.026 BSC	
H	0.30	0.50	0.012	0.020
L	0.30	0.50	0.012	0.020
L1	0.13 REF		0.005 REF	
K	0.30	-	0.012	-
θ	-	12°	-	12°

### RECOMMENDED LAND PATTERN



UNIT: mm